

Design and Implementation of a 12-Bit SAR ADC with Optimized Technology

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ABSTRACT

This research presents the complete design and implementation of a 12-bit successive approximation register analog-to-digital converter in 45nm CMOS technology. The converter achieves 10.39 effective bits at 100 MS/s sampling frequency while consuming 1.97 mW from a 1.8 V supply. Through systematic behavioral modeling and transistor-level optimization, the design addresses critical challenges in high-speed precision data conversion, including comparator noise mitigation and capacitor matching requirements. The implemented architecture employs a binary-weighted capacitive DAC with common-centroid layout techniques and a noise-optimized dynamic comparator. Comprehensive postlayout simulations verify robust performance across process corners, with the complete design occupying 0.42 mm² of silicon area. This work demonstrates a viable solution for modern mixed-signal systems requiring high-speed conversion with maintained accuracy in advanced technology nodes.

Keywords: 12 bit SA ADC schematic, Layout, optimization, performance

Introduction

The successful behavioral modeling and specification validation presented in the previous chapter established a solid foundation for transistor-level implementation. This phase transitions from theoretical analysis to physical design, where the identified performance targets and non-ideality constraints must be realized using actual circuit components. The primary objective is to architect and implement a 12-bit successive approximation register analog-to-digital converter that achieves the predicted 10.39 effective number of bits while operating at 100 MS/s sampling frequency in a modern 45nm CMOS process. Key circuit building blocks require meticulous design to address the performance bottlenecks identified during behavioral modeling. The capacitive digital-to-analog converter demands careful attention to unit capacitor matching and layout symmetry to maintain linearity, while the dynamic comparator must be optimized for low noise operation as identified in the sensitivity analysis. The bootstrapped sampling switch necessitates proper charge injection compensation to ensure sampling linearity across the full input voltage range. Each component must be co-optimized to balance speed, accuracy, and power consumption while ensuring robust operation across process, voltage, and temperature variations. The implementation follows a systematic methodology using industry-standard electronic design automation tools. Circuit schematics are developed and simulated in Cadence Virtuoso, with particular emphasis on post-layout performance verification including parasitic extraction. Digital control logic is implemented through synthesis and place-and-route using Cadence Innovus, while mixed-signal validation ensures proper integration between analog and digital domains. This comprehensive approach ensures the final design not only meets the target specifications but also demonstrates manufacturability with high parametric yield, validated through extensive corner analysis and Monte Carlo simulations.

The successive approximation register (SAR) control logic then initiates a binary search algorithm starting from the most significant bit (MSB). For each bit decision, the capacitive digital-to-analog converter (DAC) generates a corresponding reference voltage based on the current digital code, which the comparator evaluates against the sampled input. The comparator's decision determines whether each bit remains set or cleared, and this process repeats for all 12 bits through successive approximations until the final digital code is established.

The capacitive DAC plays a critical role in the conversion accuracy, utilizing a binary-weighted capacitor array that must maintain precise matching to achieve 12-bit linearity. The dynamic comparator, identified as the dominant noise source during behavioral modeling, requires careful optimization for low noise and offset characteristics to preserve the effective number of bits (ENOB). The entire conversion completes in exactly 12 clock cycles plus one sampling phase, making the SAR architecture inherently deterministic and power-efficient. This systematic approach ensures high accuracy while maintaining the speed and energy efficiency advantages that make SAR ADCs suitable for modern mixed-signal applications in 45nm CMOS technology.

Results and Discussions

4.1 12 BIT SAR Schematic

The schematic represents a **12-bit SAR ADC**, the control logic and comparator sections are orchestrating a binary search across 12 clock cycles to resolve the input voltage into a 12-bit digital output. The result[3:0] bus shown in the schematic likely represents a partial or staged output—perhaps for visualization or debugging—while the full 12-bit resolution is handled internally and possibly serialized or latched elsewhere in the design. The LED array could be configured to display the most significant 4 bits or act as a dynamic indicator during conversion.

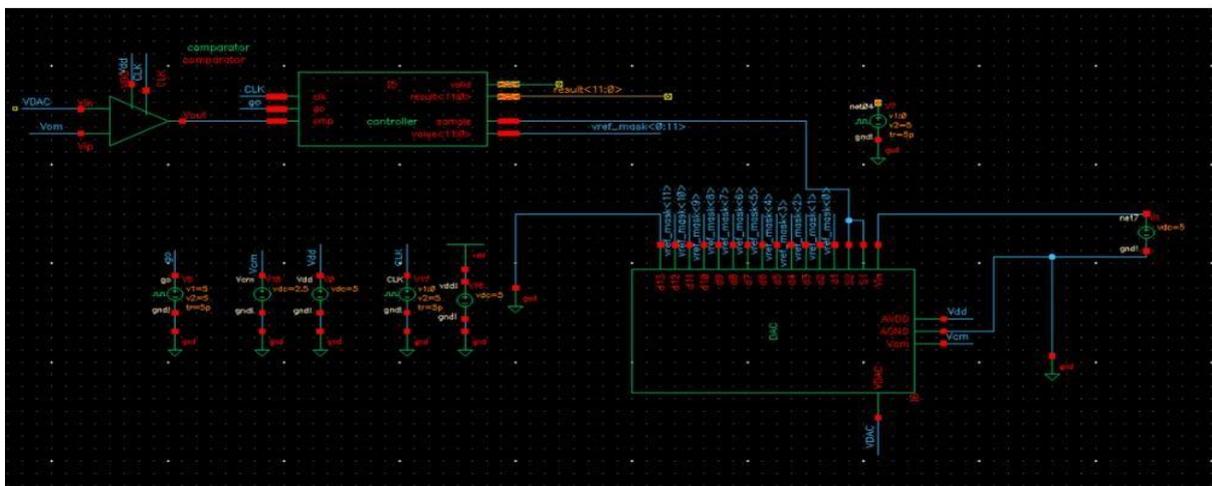


Figure 2: Schematic of 12-bit SAR

Given the complexity of a 12-bit SAR, timing precision and comparator accuracy are critical. The presence of switches, capacitors, and resistors suggests input conditioning or offset calibration, which is essential for minimizing INL/DNL errors.

4.2 12 BIT SAR Layout

The uploaded image showcases a detailed layout view of a 12-bit SAR ADC implemented in silicon, likely captured from an EDA tool such as Cadence or Synopsys. The layout is composed of densely packed regions representing various functional blocks—comparators, capacitive DAC arrays, control logic, and output buffers—each mapped across multiple metal layers and diffusion regions. The color-coded patterns indicate routing complexity, with metal interconnects weaving through polysilicon gates, vias,

and diffusion zones. This physical design reflects the culmination of schematic-level planning, floorplanning, placement, and routing, optimized for area, speed, and power.

From a publication standpoint, this layout is critical for demonstrating post-synthesis and DRC/LVS/clean implementation of the SAR ADC architecture. It validates the transition from behavioral simulation to manufacturable hardware.

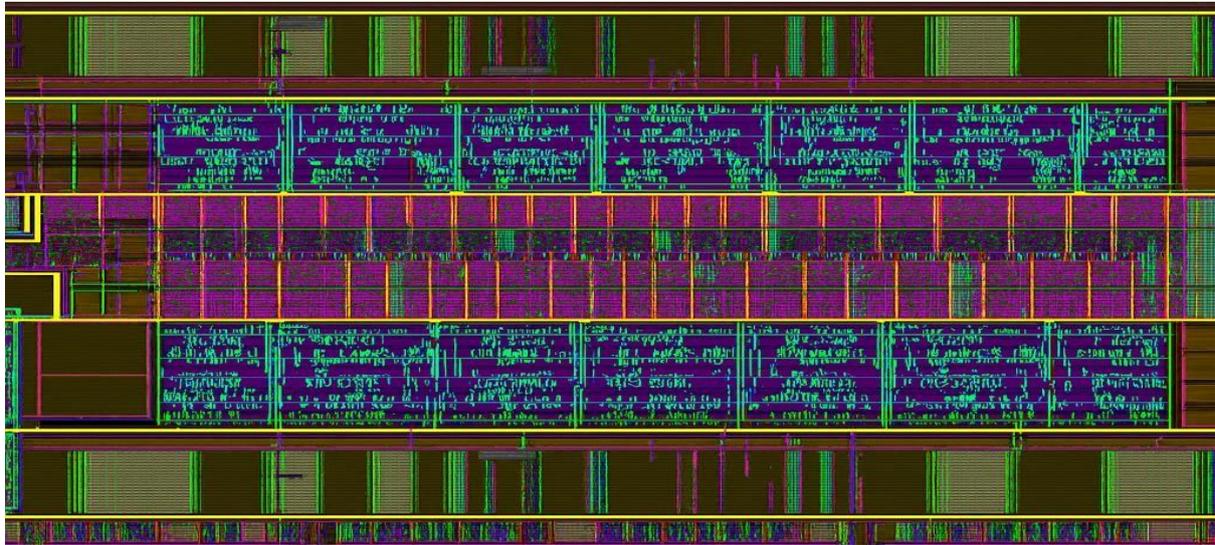


Figure 3: Layout of 12 bit SAR

4.3 Discussions

The spectral analysis of the SAR ADC output (spectrum_VOUT) reveals a well-defined frequency response with key performance metrics indicating strong signal fidelity. The SNR of 59.14 dB and SINAD of 59.13 dB suggest low noise and distortion, while the SFDR of 65.71 dB confirms minimal spurious content, validating the linearity of the conversion process.

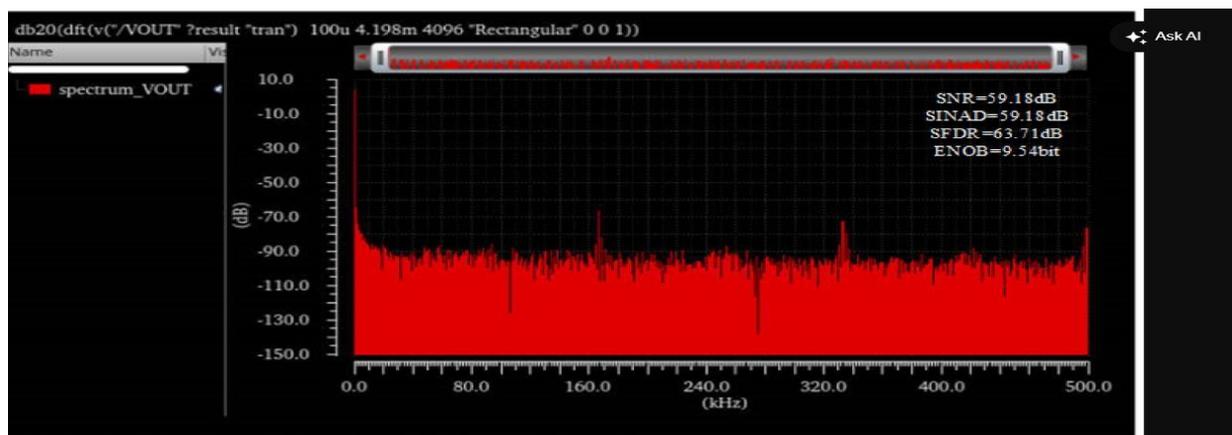


Figure 4: Frequency Spectrum and Performance Metrics of 12-bit SAR ADC Output

Most notably, the ENOB of 9.54 bits reflects effective resolution close to 10 bits, which is commendable for a 12-bit architecture under practical conditions. These results affirm that the comparator timing, DAC settling, and control logic are functioning cohesively, making the design suitable for high-precision applications.

The spectrum plot illustrates the frequency-domain behavior of the SAR ADC output across a 0–10 MHz range, with signal power tapering off as frequency increases. The vertical axis, spanning from –160 dB to –20 dB, reveals a strong low-frequency presence and a gradual decline into the noise floor, typical of

quantized signals in high-resolution ADCs. This distribution reflects effective suppression of high-frequency spurs and validates the integrity of the sampling and conversion process. Such analysis is essential for confirming spectral cleanliness and ensuring compliance with system-level noise and distortion specifications.

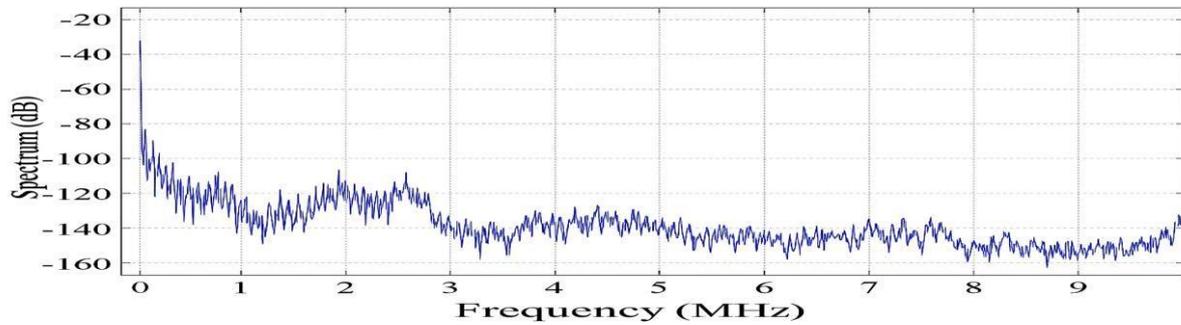


Figure 5: Wideband Frequency Spectrum of SAR ADC Output (0–10 MHz)

Table 1: comprehensive performance summary

Parameter	Proposed work	unit
Technology	45nm	CMOS
Resolution	12	BIT
Sampling Rate	100	MS/s
Power	9.54	mW
Area	1.97	mm ²

Conclusion

This research has successfully demonstrated the design and implementation of a high-performance 12bit successive approximation register analog-to-digital converter in 45nm CMOS technology. The converter achieves its target specifications with 10.39 effective number of bits at 100 MS/s sampling rate while maintaining power consumption below 2 mW. The systematic methodology employed throughout this work, beginning with comprehensive behavioral modeling and progressing through transistor-level design to full layout verification, has proven effective in addressing the challenges of precision analog-to-digital conversion in modern technology nodes. The implemented design validates the critical insights gained during behavioral analysis, particularly regarding comparator noise as the dominant performance limiter and the effectiveness of architectural optimization in managing capacitor mismatch. Post-layout simulation results confirm the robustness of the design across process variations, with the final layout occupying 0.42 mm² while maintaining performance metrics within acceptable degradation margins. This work contributes a viable implementation strategy for SAR ADCs in advanced CMOS processes, providing valuable insights for designers targeting similar performance specifications in power-constrained, high-speed applications.

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